

China Semiconductor Packaging Material Market Research Report 2016

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Abstracts

Notes:

Sales, means the sales volume of Semiconductor Packaging Material

Revenue, means the sales value of Semiconductor Packaging Material

This report studies Semiconductor Packaging Material in China market, focuses on the top players in China market, with capacity, production, price, revenue and market share for each manufacturer, covering

Honeywell
Fujitsu
Rohm
Goldstar
Tessera
Aptos
FCT
EPIC



GE
NEC
Sony
Panasonic
Split by product Type, with production, revenue, price, market share and growth rate of each type, can be divided into
Plastic
Metal
Ceramics
Split by Application, this report focuses on consumption, market share and growth rate of Semiconductor Packaging Material in each application, can be divided into
Communications Industry
Aerospace
Electrical Appliances
Other



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